	BLE STAN	DARD							
	OPERATING TEMPERATURE RANGE		-55 °C TO 85 °	°C (1)	STORAGE TEMPERATU	RE RANGE	-10 °C TO 60 °((2)	
RATING	VOLTAGE		100 V AC	I	OPERATING RANGE	HUMIDITY	40 % TO 80 %		
	CURRENT		0.5 A		STORAGE HI	JMIDITY	40 % TO 70 °	2/n (2)	
	POUVENI			IFICATI			70 70 10 70	, U \ '	
IT	EM	1	TEST METHOD		110	RF∩I	UIREMENTS	ТОТ	A
CONSTRU			TEST WILTHOU			I\LQ!	OH (LIVILINI O	العا	1~
		VISUALL	Y AND BY MEASURING INS	STRUMENT.	ACCO	RDING TO E	DRAWING.	×	×
MARKING		CONFIRMED VISUALLY.						×	×
	CHARAC	TERISTI	CS						
INSULATION RESISTANCE		100 V DC.				500 MΩ MIN.			
VOLTAGE PROOF		300 V AC FOR 1 min.			NO FL	NO FLASHOVER OR BREAKDOWN.			
	CAL CHAR	l						×	
MECHANICAL OPERATION		50 TIMES INSERTIONS AND EXTRACTIONS.			I	NO DAMAGE, CRACK AND LOOSENESS OF PARTS.			
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGL AMPLITUDE: 0.76 mm, AT 2 h FOR 3 DIRECTION.						×	
SHOCK		490 m/s ² , DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.						×	
LOCK STRENGTH		MATE TO APPLICABLE CONNECTOR AND APPLY PULL FORCE HORIZONTALLY.			LY	30 N MIN.			
LANCE STRENGTH		INSERT APPLICABLE CONTACT AND PULL CABLE.			BLE.	5 N MIN.		×	
			TERISTICS		T _@			Τ×	
DAMP HEAT (STEADY STATE)		EXPOSED AT 40±2 °C, 90 ~ 95 %, 96 h.			② NO	① INSULATION RESISTANCE: 500 MΩ MIN. ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.			
DRY HEAT		EXPOSEI	-,			PARTS.			
RAPID CHANGE OF TEMPERATURE		TEMPERATURE $-55 \rightarrow +5 \sim +35 \rightarrow +85 \rightarrow +5 \sim +35 \circ C$ TIME $30 \rightarrow 5 \text{ MAX} \rightarrow 30 \rightarrow 5 \text{ MAX min.}$ UNDER 5 CYCLES.			l l			×	
CORROSION SALT MIST		EXPOSED IN 5 % SALT WATER SPRAY FOR 48 h.			R NO HE	NO HEAVY CORROSION.			
SULFUR DIOXIDE		EXPOSED IN 10 PPM FOR 96 h. (TEST STANDARD: JIS-C-0090)						×	
RESISTANCE TO SOLDERING HEAT		SOLDERING IRONS : 360°C MAX. FOR 3 sec.			1		N OF CASE OF EXCESSIVE HE TERMINAL.	×	
COUN	IT D	ESCRIPTI(ON OF REVISIONS	D	ESIGNED		CHECKED	DA	ATE
REMARKS	(¹⁾ INCLUDE TEI ²⁾ "STORAGE" N FOR THE UNI	MPRERATU EANS A LC JSED PROD	RE RISE CAUSED BY CURREI NG-TERM STORAGE STATE DUCT BEFORE ASSEMBLY TO	NT-CARRYING		APPROVEI CHECKEE DESIGNEE DRAWN	D HS. OKAWA D HT. YAMAGUCHI	05. C 05. C 05. C)8. 0!)8. 0!)8. 0!
REMARKS	(1) INCLUDE TE 2) "STORAGE" M FOR THE UNI	MPRERATU EANS A LO USED PROD ecified, r	RE RISE CAUSED BY CURREING-TERM STORAGE STATE DUCT BEFORE ASSEMBLY TO	NT-CARRYING PCB.	3.	CHECKED DESIGNED DRAWN	D HS. OKAWA D HT. YAMAGUCHI D KN. SHIBUYA KN. SHIBUYA	05. 0 05. 0 05. 0	08. 09 08. 09 08. 09
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